Presettable synchronous 4-bit binary counter; synchronous reset

Rev. 3 — 2 June 2014

**Product data sheet** 

### 1. General description

The 74HC163; 74HCT163 is a synchronous presettable binary counter with an internal look-head carry. Synchronous operation is provided by having all flip-flops clocked simultaneously on the positive-going edge of the clock (CP). The outputs (Q0 to Q3) of the counters may be preset to a HIGH or LOW. A LOW at the parallel enable input ( $\overline{PE}$ ) disables the counting action. It causes the data at the data inputs (D0 to D3) to be loaded into the counter on the positive-going edge of the clock. Preset takes place regardless of the levels at count enable inputs (CEP and CET). A LOW at the master reset input (MR) sets Q0 to Q3 LOW after the next positive-going transition on the clock input (CP). This action occurs regardless of the levels at input pins PE, CET and CEP. This synchronous reset feature enables the designer to modify the maximum count with only one external NAND gate. The look-ahead carry simplifies serial cascading of the counters. Both CEP and CET must be HIGH to count. The CET input is fed forward to enable the terminal count output (TC). The TC output thus enabled will produce a HIGH output pulse of a duration approximately equal to a HIGH output of Q0. This pulse can be used to enable the next cascaded stage. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

The CP to TC propagation delay and CEP to CP set-up time determine the maximum clock frequency for the cascaded counters according to the following formula:

$$f_{max} = \frac{I}{t_{P(max)}(CPtoTC) + t_{SU}(CEPtoCP)}$$

### 2. Features and benefits

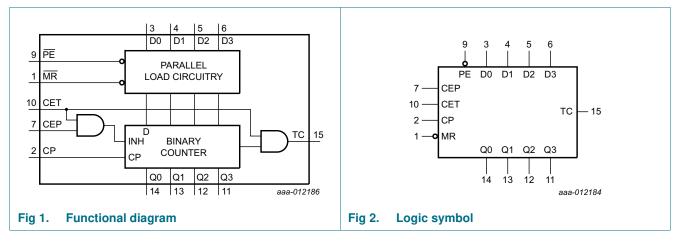
- Complies with JEDEC standard no. 7A
- Input levels:
  - For 74HC163: CMOS level
  - For 74HCT163: TTL level
- Synchronous counting and loading
- 2 count enable inputs for n-bit cascading
- Synchronous reset
- Positive-edge triggered clock
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from –40 °C to +85 °C and –40 °C to +125 °C

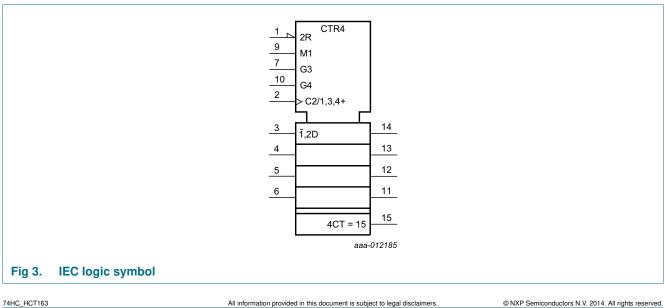


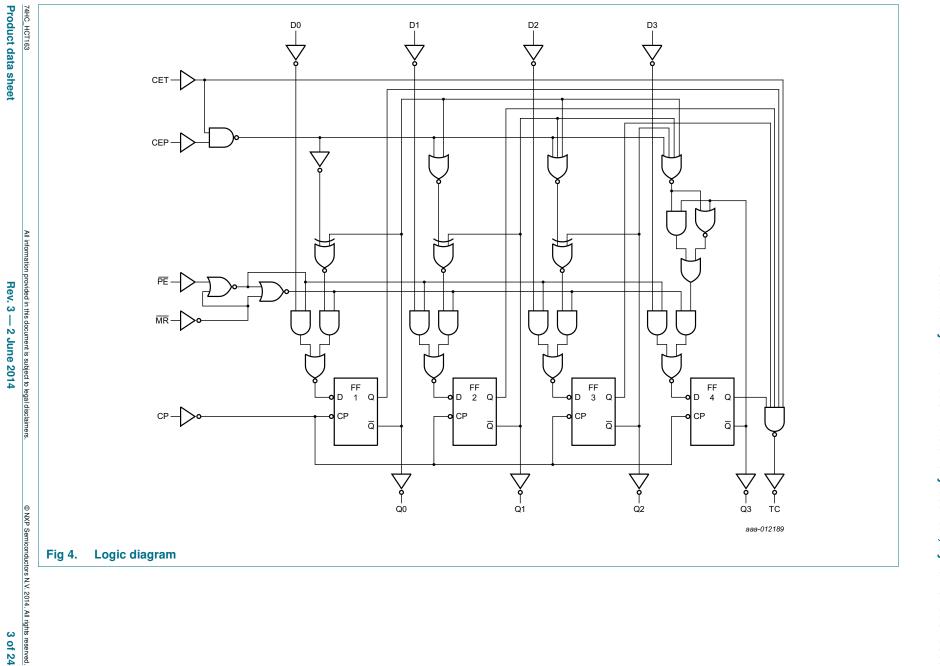
## 3. Ordering information

74HCT163N	Package	Package									
	Temperature range	Name	Description	Version							
74HC163N	–40 °C to +125 °C	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4							
74HCT163N											
74HC163D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1							
74HCT163D			body width 3.9 mm								
74HC163DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads;	SOT338-1							
74HCT163DB			body width 5.3 mm								
74HC163PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1							
74HCT163PW			body width 4.4 mm								

## 4. Functional diagram







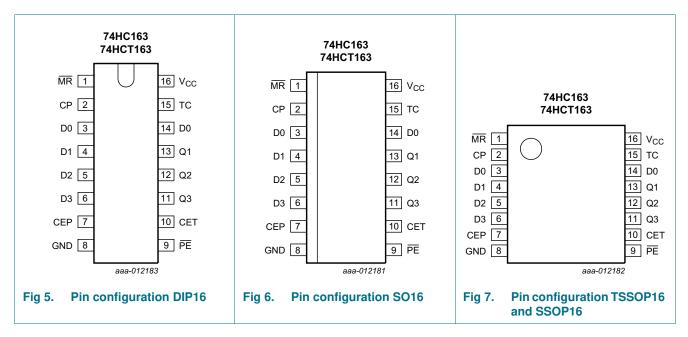
Presettable synchronous 4-bit binary counter; synchronous reset 74HC163; 74HCT163

**NXP Semiconductors** 

Presettable synchronous 4-bit binary counter; synchronous reset

## 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

#### Table 2.Pin description

Symbol	Pin	Description
MR	1	synchronous master reset (active LOW)
СР	2	clock input (LOW-to-HIGH, edge triggered)
D0, D1, D2, D3	3, 4, 5, 6	data input
CEP	7	count enable input
GND	8	ground (0 V)
PE	9	parallel enable input (active LOW)
CET	10	count enable carry input
Q0, Q1, Q2, Q3	14, 13, 12, 11	flip-flop output
TC	15	terminal count output
V <sub>CC</sub>	16	supply voltage

## 6. Functional description

#### Table 3.Function table<sup>[1]</sup>

Operating mode	Inputs	Inputs									
	MR	СР	CEP	CET	PE	Dn	Qn	тс			
Reset (clear)	I	1	Х	Х	Х	Х	L	L			
Parallel load	h	$\uparrow$	Х	Х	I	I	L	L			
	h	$\uparrow$	Х	Х	I	h	Н	L			
Count	h	$\uparrow$	h	h	h	Х	count				
Hold (do nothing)	h	Х	I	Х	h	Х	qn	L			
	h	Х	Х	I	h	Х	qn	L			

[1] The TC output is HIGH when CET is HIGH and the counter is at terminal count (HHHH);

H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition;

L = LOW voltage level;

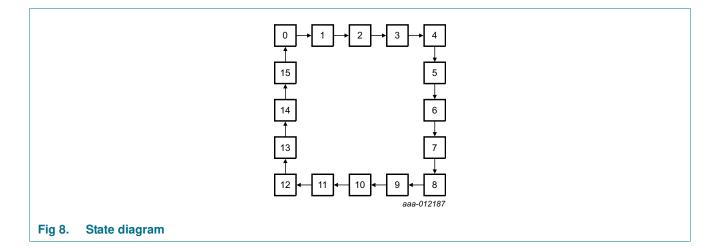
I = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition;

q = lower case letters indicate the state of the referenced output one set-up time prior to the

LOW-to-HIGH CP transition;

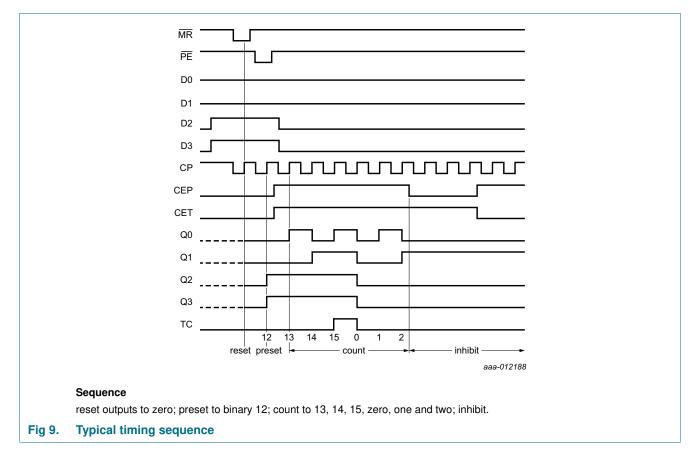
X = don't care;

 $\uparrow$  = LOW-to-HIGH clock transition.



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#### Presettable synchronous 4-bit binary counter; synchronous reset



## 7. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	$V_{1} < -0.5$ V or $V_{1} > V_{CC} + 0.5$ V		-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V		-	±20	mA
lo	output current	$V_{O} = -0.5$ V to $V_{CC}$ + 0.5 V		-	±25	mA
I <sub>CC</sub>	supply current			-	50	mA
I <sub>GND</sub>	ground current			-50	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	DIP16 package	<u>[1]</u>	-	750	mW
		SO16 package	<u>[1]</u>	-	500	mW
		(T)SSOP16 package	[1]	-	500	mW

[1] For DIP16 packages: above 70  $^\circ\text{C}$  the value of P\_tot derates linearly at 12 mW/K.

For SO16 packages: above 70  $^{\circ}\text{C}$  the value of P<sub>tot</sub> derates linearly at 8 mW/K.

For (T)SSOP16 packages: above 60 °C the value of Ptot derates linearly at 5.5 mW/K.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC	163		74HC	74HCT163			
			Min	Тур	Max	Min	Тур	Max		
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V	
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V	
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V	
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C	
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V	
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V	
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V	

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	-
74HC16	3									
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0; V_{CC} = 4.5 V$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2; V_{CC} = 6.0 V$	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>CC</sub>	supply current		-	-	8.0	-	80.0	-	160.0	μA

### Presettable synchronous 4-bit binary counter; synchronous reset

#### Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
CI	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT16	63									
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 4.5 V \text{ to } 5.5 V$	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC} = 4.5 V \text{ to } 5.5 V$	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		l <sub>O</sub> = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>CC</sub>	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 5.5 \ V \end{array}$	-	-	8.0	-	80.0	-	160.0	μA
Δl <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.1 V$ ; other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 V$ to 5.5 V; $I_0 = 0 A$								
		pin MR	-	95	342	-	427.5	-	465.5	μA
		pin CP	-	110	396	-	495	-	539	μA
		pin CEP and Dn	-	25	90	-	112.5	-	122.5	μA
		pin CET	-	75	270	-	337.5	-	367.5	μA
		pin PE	-	30	108	-	135	-	147	μA
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

Presettable synchronous 4-bit binary counter; synchronous reset

## **10. Dynamic characteristics**

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see <u>Figure 15</u>.

Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
74HC16	3	1				I				
t <sub>pd</sub>	propagation	CP to Qn; see Figure 10 [1]	-							
	delay	V <sub>CC</sub> = 2.0 V	-	55	185	-	230	-	280	ns
		V <sub>CC</sub> = 4.5 V	-	20	37	-	46	-	56	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	17	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	16	31	-	39	-	48	ns
		CP to TC; see Figure 10								
		V <sub>CC</sub> = 2.0 V	-	69	215	-	270	-	320	ns
		V <sub>CC</sub> = 4.5 V	-	25	43	-	54	-	65	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	21	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$	-	20	37	-	46	-	55	ns
		CET to TC; see Figure 11								
		V <sub>CC</sub> = 2.0 V	-	36	120	-	150	-	180	ns
		V <sub>CC</sub> = 4.5 V	-	13	24	-	30	-	36	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	11	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	10	20	-	26	-	31	ns
tt	transition	see Figure 10 and Figure 11 [2]								
	time	V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
tw	pulse width	CP; HIGH or LOW;								
		see <u>Figure 10</u>	00	47		100		100		
		$V_{CC} = 2.0 V$	80	17	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	6	-	20	-	24	-	ns
		$V_{CC} = 6.0 V$	14	5	-	17	-	20	-	ns

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### Presettable synchronous 4-bit binary counter; synchronous reset

Symbol	Parameter	Conditions		25 °C		-40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t <sub>su</sub>	set-up time	MR, Dn to CP; see Figure 12 and Figure 13								
		V <sub>CC</sub> = 2.0 V	80	17	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	6	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	5	-	17	-	20	-	ns
		PE to CP; see Figure 12								
		V <sub>CC</sub> = 2.0 V	80	22	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	8	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns
		CEP, CET to CP; see <u>Figure 14</u>								
		V <sub>CC</sub> = 2.0 V	175	58	-	220	-	265	-	ns
		V <sub>CC</sub> = 4.5 V	35	21	-	44	-	53	-	ns
		V <sub>CC</sub> = 6.0 V	30	17	-	37	-	45	-	ns
t <sub>h</sub>	hold time	Dn, PE, CEP, CET, MR to CP; see Figure 12, Figure 13 and Figure 14								
		V <sub>CC</sub> = 2.0 V	0	-14	-	0	-	0	-	ns
		V <sub>CC</sub> = 4.5 V	0	-5	-	0	-	0	-	ns
		V <sub>CC</sub> = 6.0 V	0	-4	-	0		0	-	ns
f <sub>max</sub>	maximum	CP; see Figure 10								
	frequency	V <sub>CC</sub> = 2.0 V	5	15	-	4	-	4	-	MHz
		V <sub>CC</sub> = 4.5 V	27	46	-	22	-	18	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	51	-	-	-	-	-	MHz
		V <sub>CC</sub> = 6.0 V	32	55	-	26	-	21	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$V_1 = GND$ to $V_{CC}$ ; $V_{CC} = 5 V$ ; [3] $f_i = 1 MHz$	-	33	-	-	-	-	-	pF

#### Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 15.

### Presettable synchronous 4-bit binary counter; synchronous reset

Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	-
74HCT1	93	1				I		1		
t <sub>pd</sub>	propagation	CP to Qn; see Figure 10	1							
	delay	V <sub>CC</sub> = 4.5 V	-	23	39	-	49	-	59	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
		CP to TC; see Figure 10								
		V <sub>CC</sub> = 4.5 V	-	29	49	-	61	-	74	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	25	-	-	-	-	-	ns
		CET to TC; see Figure 11								
		V <sub>CC</sub> = 4.5 V	-	17	32	-	44	-	48	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	14	-	-	-	-	-	ns
t <sub>t</sub>	transition	see Figure 10 and Figure 11	1							
	time	V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
tw	pulse width	CP; HIGH or LOW;								
		see Figure 10								
		$V_{CC} = 4.5 V$	20	6	-	25	-	30	-	ns
t <sub>su</sub>	set-up time	MR, Dn to CP; see <u>Figure 12</u> and <u>Figure 13</u>								
		$V_{CC} = 4.5 V$	20	9	-	25	-	30	-	ns
		PE to CP; see Figure 12								-
		V <sub>CC</sub> = 4.5 V	20	11	-	25	-	30	-	ns
		CEP, CET to CP; see Figure 14								
		V <sub>CC</sub> = 4.5 V	40	24	-	50	-	60	-	ns
t <sub>h</sub>	hold time	Dn, PE, CEP, CET, MR to CP; see <u>Figure 12</u> , <u>Figure 13</u> and <u>Figure 14</u>								
		V <sub>CC</sub> = 4.5 V	0	-5	-	0	-	0	-	ns
f <sub>max</sub>	maximum	CP; see Figure 10								
	frequency	V <sub>CC</sub> = 4.5 V	26	45	-	21	-	17	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	50	-	-	-	-	-	MHz

#### Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; for test circuit see <u>Figure 15</u>.

### Presettable synchronous 4-bit binary counter; synchronous reset

#### Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 15.

Symbol	Parameter	Conditions	25 °C		25 °C –40 °C to +85 °C -		–40 °C to	Unit		
			Min	Тур	Max	Min	Max	Min	Max	
C <sub>PD</sub>	power dissipation capacitance	$V_{I} = \text{GND to } V_{CC} - 1.5 \text{ V};$ $V_{CC} = 5 \text{ V}; f_{i} = 1 \text{ MHz}$ $3$	-	35	-	-	-	-	-	pF

[1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .

[2]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ):

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

 $f_o$  = output frequency in MHz;

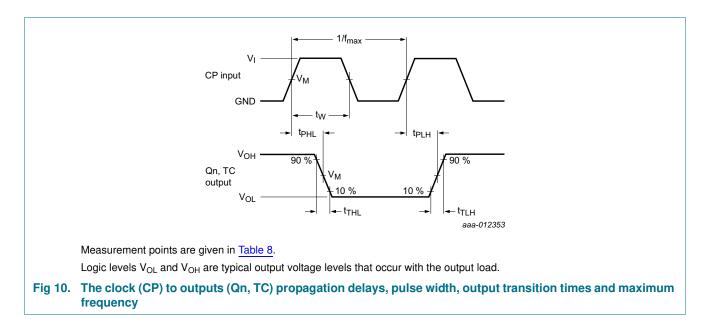
 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

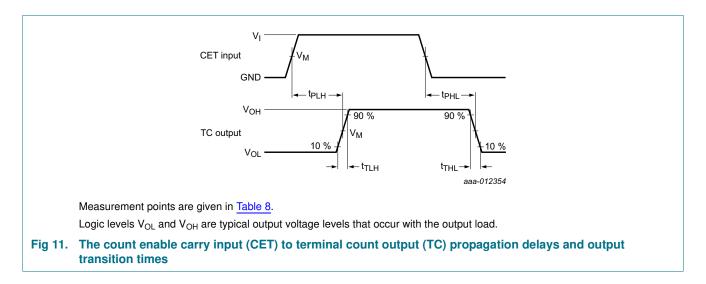
 $\sum (C_L \times V_{CC}{}^2 \times f_o)$  = sum of outputs.

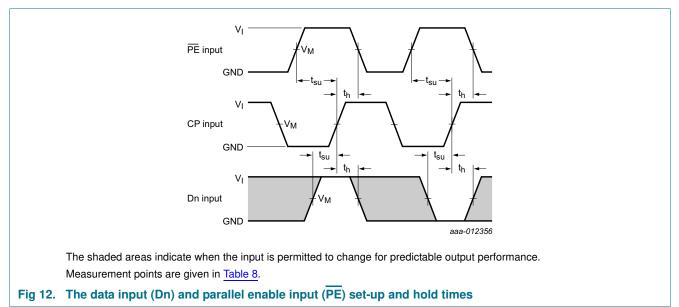
## 11. Waveforms



# 74HC163; 74HCT163

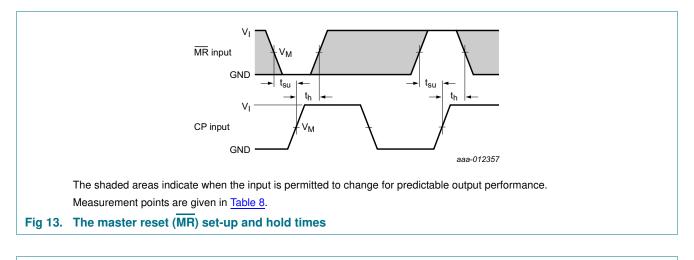
### Presettable synchronous 4-bit binary counter; synchronous reset

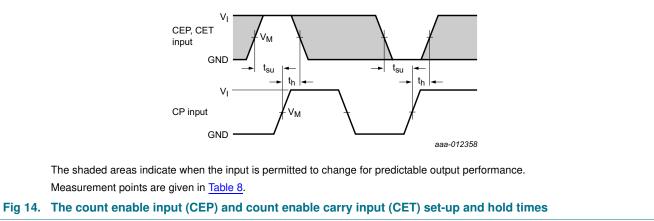




# 74HC163; 74HCT163

### Presettable synchronous 4-bit binary counter; synchronous reset





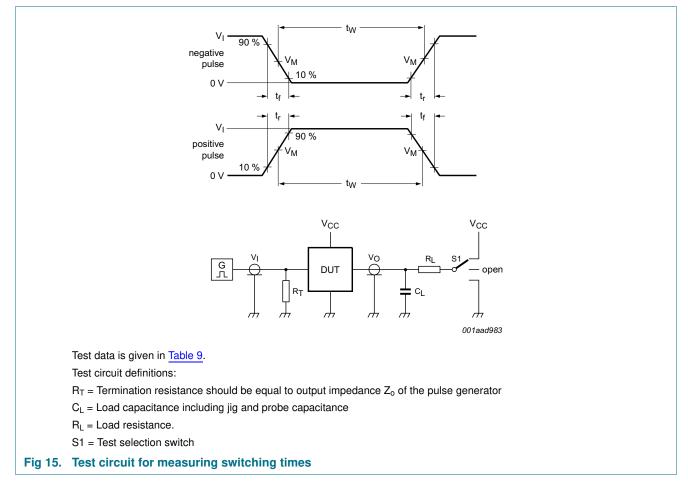
#### Table 8. Measurement points

Туре	Input		Output
	V <sub>M</sub>	VI	V <sub>M</sub>
74HC163	$0.5  imes V_{CC}$	GND to V <sub>CC</sub>	$0.5  imes V_{CC}$
74HCT163	1.3 V	GND to 3 V	1.3 V

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# 74HC163; 74HCT163

### Presettable synchronous 4-bit binary counter; synchronous reset



#### Table 9.Test data

Туре	Input		Load		S1 position
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHL</sub> , t <sub>PLH</sub>
74HC163	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open
74HCT163	3 V	6 ns	15 pF, 50 pF	1 kΩ	open

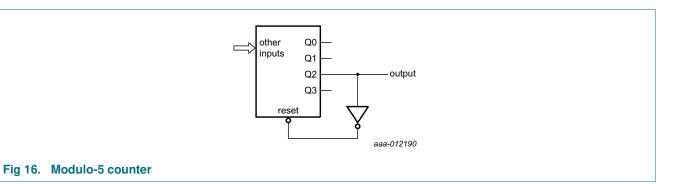
15 of 24

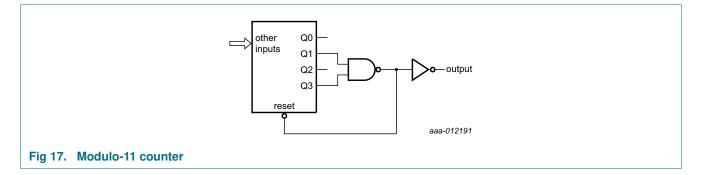
# 74HC163; 74HCT163

Presettable synchronous 4-bit binary counter; synchronous reset

## **12. Application information**

The 74HC163; 74HCT63 facilitate designing counters of any modulus with minimal external logic. The output is glitch-free due to the synchronous reset.

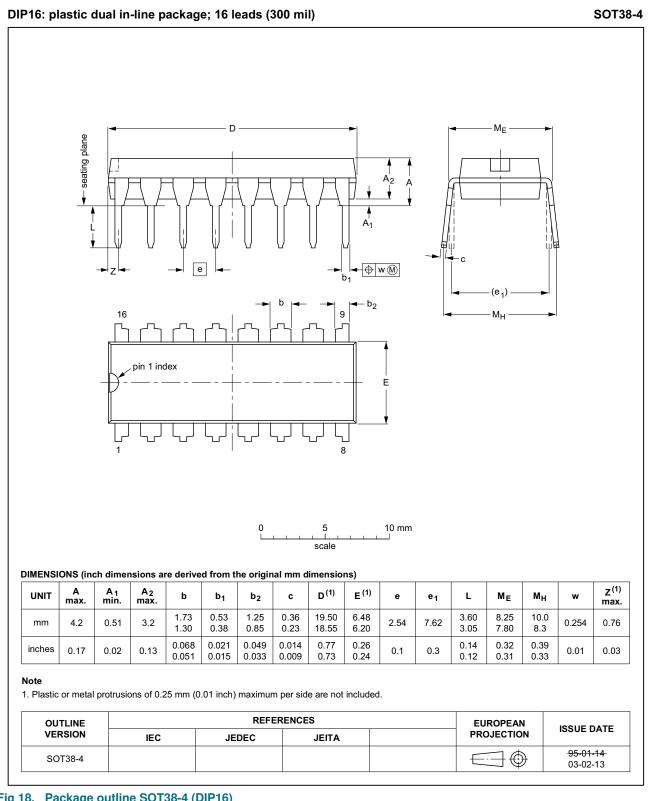




# 74HC163; 74HCT163

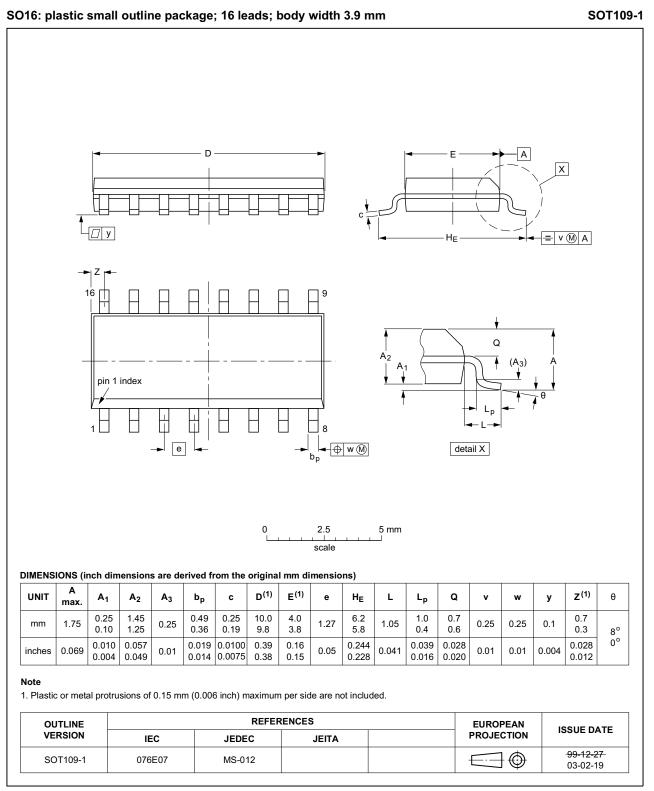
Presettable synchronous 4-bit binary counter; synchronous reset

## 13. Package outline



#### Fig 18. Package outline SOT38-4 (DIP16)

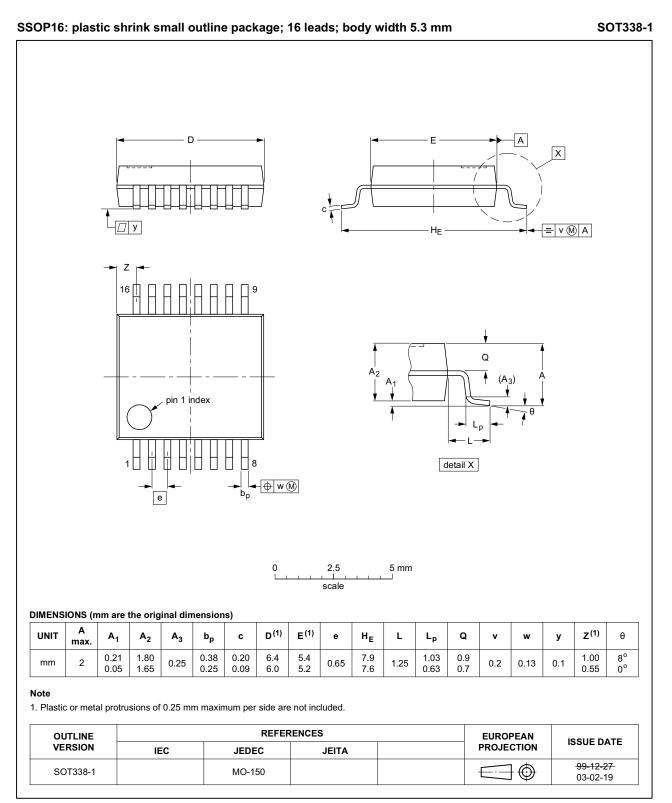
Presettable synchronous 4-bit binary counter; synchronous reset



#### Fig 19. Package outline SOT109-1 (SO16)

74HC\_HCT163 Product data sheet

Presettable synchronous 4-bit binary counter; synchronous reset

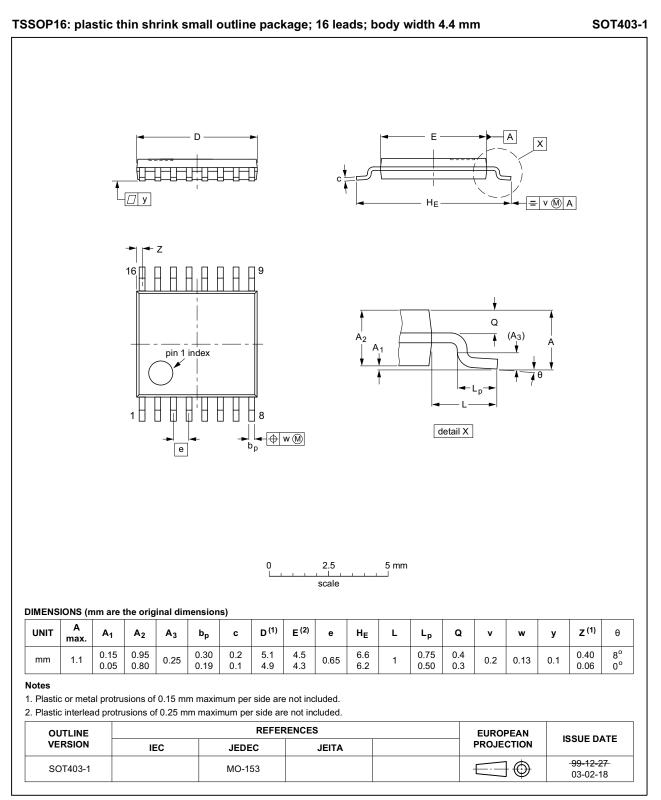


### Fig 20. Package outline SOT338-1 (SSOP16)

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74HC\_HCT163

Presettable synchronous 4-bit binary counter; synchronous reset



#### Fig 21. Package outline SOT403-1 (TSSOP16)

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## 14. Abbreviations

Table 10. Abbreviations		
Acronym	Description	
CMOS	Complementary Metal-Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
НВМ	Human Body Model	
LSTTL	Low-power Schottky Transistor-Transistor Logic	
MM	Machine Model	
TTL	Transistor-Transistor Logic	

## **15. Revision history**

### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT163 v.3	20140602	Product data sheet	-	74HC_HCT163_CNV v.2
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>			
	Legal texts have been adapted to the new company name where appropriate.			
74HC_HCT163_CNV v.2	19930927	Product specification	-	-

## 16. Legal information

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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